

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant(s): Lee John Smith, David Albert Zoba
Assignee: Amkor Technology, Inc.
Title: THIN SEMICONDUCTOR PACKAGE INCLUDING STACKED DIES
Serial No.: 09/944,732 Filed: August 31, 2001
Examiner: David E. Graybill Group Art Unit: 2822
Docket No.: G0079

Chandler, AZ

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

**REVOCATION AND SUBSTITUTION
OF POWER OF ATTORNEY UNDER 37 C.F.R. §1.36**

Sir:

Pursuant to 37 C.F.R. §1.36, Amkor Technology, Inc., the record owner of the above-identified patent application, revokes all previous powers of attorney and hereby appoints the following attorneys and/or agents assigned to the below Customer Number to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith:

Customer Number 23513

Please direct all correspondence and telephone calls concerning this application to:

Serge J. Hodgson
GUNNISON, MCKAY & HODGSON, L.L.P.
1900 Garden Road, Suite 220
Monterey, CA 93940
Telephone: (831) 655-0880
Facsimile: (831) 655-0888.

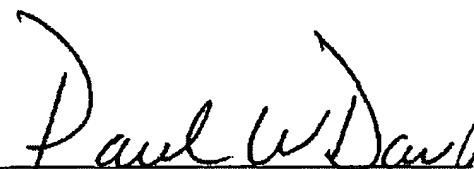
GUNNISON, MCKAY &
HODGSON, L.L.P.
1900 Garden Road, Suite 220
Monterey, CA 93940
(831) 655-0880
Fax: (831) 655-0888

The undersigned representative of the above-identified assignee certifies that the above-identified assignee is the assignee of the entire right, title and interest in the above-identified patent application by virtue of a chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee.

An Assignment from the inventor(s) of the patent application to Amkor Technology, Inc. was recorded in the U.S. Patent and Trademark Office at Reel/Frame 012143/0366.

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the above-identified assignee.

Signature:



Paul W. Davis Date: 10/20/04

Name: Paul W. Davis

Title: Vice President of Intellectual Property Law
Amkor Technology, Inc.

RECEIVED
OCT 28 2004
PATENT & TRADEMARK OFFICE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Lee John Smith et al.

Assignee: Amkor Technology, Inc.

Title: THIN SEMICONDUCTOR PACKAGE INCLUDING STACKED DIES

Serial No.: 09/944,732 Filed: August 31, 2001

Examiner: David E. Graybill Group Art Unit: 2822

Docket No.: G0079

Monterey, CA
October 22, 2004

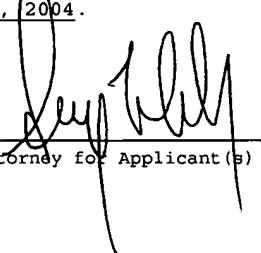
Mail Stop Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR CHANGE OF ATTORNEY DOCKET NUMBER

Dear Sir:

Please change the Attorney Docket Number in the above application from "M-11443 US" to "G0079". Please use Attorney Docket Number "G0079" in all future correspondence with Applicant's attorney.

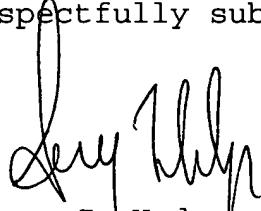
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage for First Class Mail in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on October 22, 2004.



Attorney for Applicant(s)

October 22, 2004
Date of Signature

Respectfully submitted,



Serge J. Hodgson
Attorney for Applicant(s)
Reg. No. 40,017
(831) 655-0880